

## N&P-Channel complementary Power MOSFET

### Description

The HM603K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

#### N channel

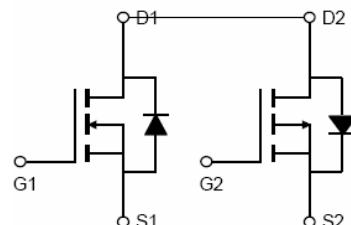
- $V_{DS} = 60V, I_D = 20A$
- $R_{DS(ON)} < 30m\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 35m\Omega @ V_{GS} = 4.5V$

#### p channel

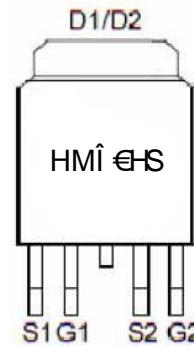
- $V_{DS} = -60V, I_D = -15A$
- $R_{DS(ON)} < 85m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} < 135m\Omega @ V_{GS} = -4.5V$
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

### Application

- H-bridge
- Inverters



Schematic diagram



Marking and pin assignment

**100% UIS TESTED!**

**100%  $\Delta V_{ds}$  TESTED!**

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HM603K	HM603K	TO-252-4L			

### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		$V_{DS}$	60	-60	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current <small><math>T_c=25^\circ C</math></small>	$T_c=25^\circ C$	$I_D$	20	-15	A
	$T_c=100^\circ C$		14	-10.5	
Pulsed Drain Current <small>(Note 1)</small>		$I_{DM}$	60	-45	A
Maximum Power Dissipation	$T_c=25^\circ C$	$P_D$	50		W
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55 To 175		°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case <small>(Note 2)</small>	$R_{\theta JC}$	3	°C/W
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**N-Channel Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> (Note 3)						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.2	1.7	2.3	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	-	24	30	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$		28	35	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=5\text{A}$	11	-	-	S
<b>Dynamic Characteristics</b> (Note 4)						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	900	-	PF
Output Capacitance	$C_{\text{oss}}$		-	60	-	PF
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	25	-	PF
<b>Switching Characteristics</b> (Note 4)						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=30\text{V}, I_{\text{D}}=2\text{A}, R_{\text{L}}=6.7\Omega$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\Omega$	-	5	-	nS
Turn-on Rise Time	$t_{\text{r}}$		-	2.6	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	16.1	-	nS
Turn-Off Fall Time	$t_{\text{f}}$		-	2.3	-	nS
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=4.5\text{A}, V_{\text{GS}}=10\text{V}$	-	25	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	4.5	-	nC
Gate-Drain Charge	$Q_{\text{gd}}$		-	6.5	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$	-		1.2	V
Diode Forward Current (Note 2)	$I_{\text{S}}$		-	-	20	A
Reverse Recovery Time	$t_{\text{rr}}$	$T_{\text{J}} = 25^\circ\text{C}, \text{IF} = 20\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$ (Note 3)	-	29	-	nS
Reverse Recovery Charge	$Q_{\text{rr}}$		-	49	-	nC
Forward Turn-On Time	$t_{\text{on}}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition:  $T_j=25^\circ\text{C}, V_{\text{DD}}=30\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$

### N-Channel Typical Electrical and Thermal Characteristics (Curves)

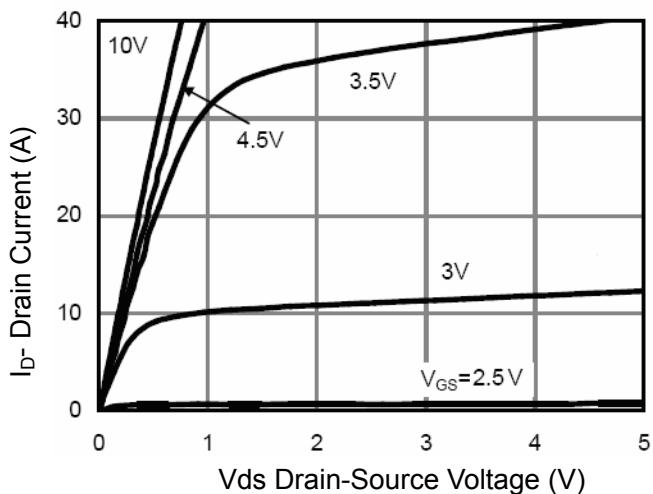


Figure 1 Output Characteristics

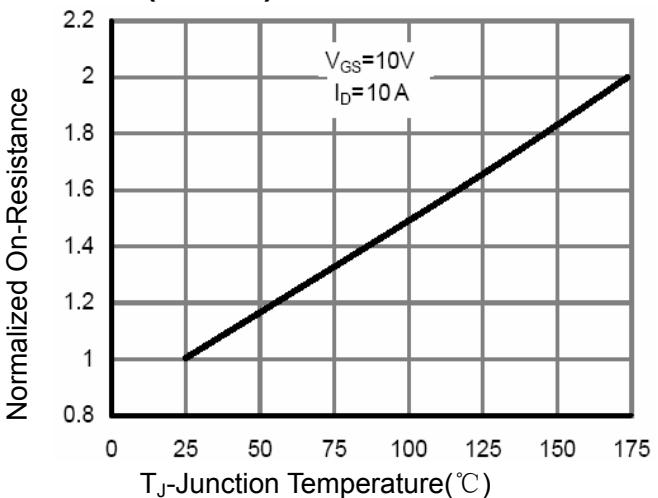


Figure 4 Rdson-Junction Temperature

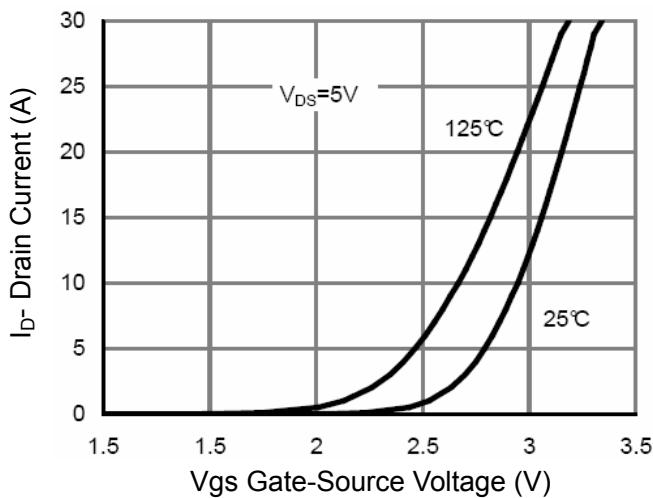


Figure 2 Transfer Characteristics

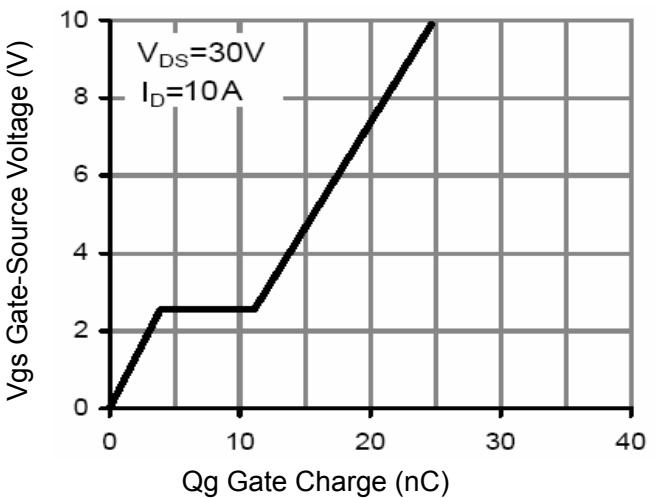


Figure 5 Gate Charge

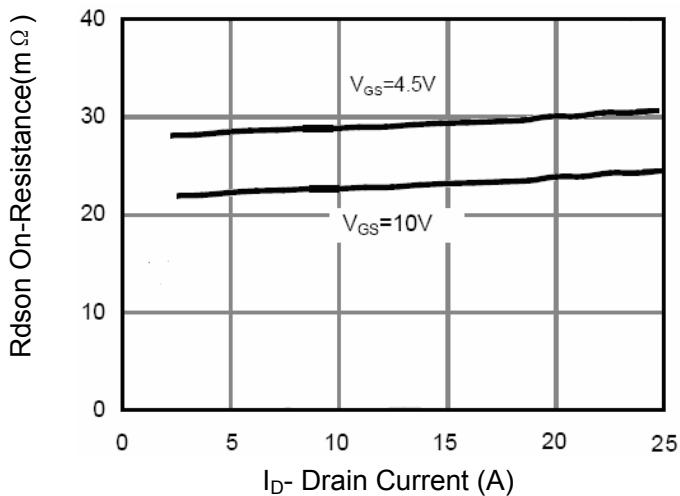


Figure 3 Rdson- Drain Current

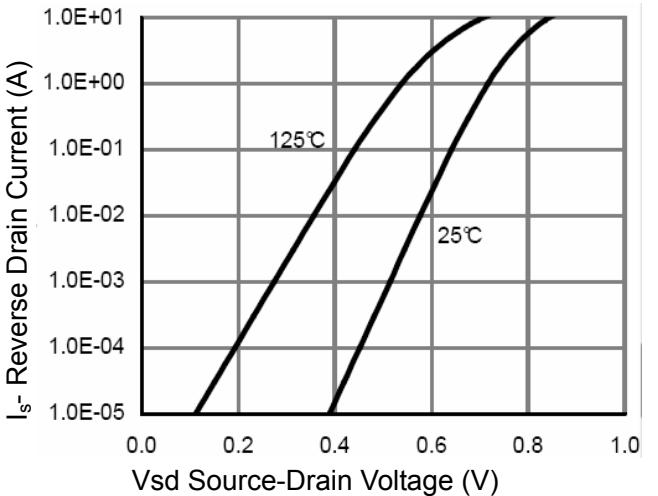


Figure 6 Source- Drain Diode Forward

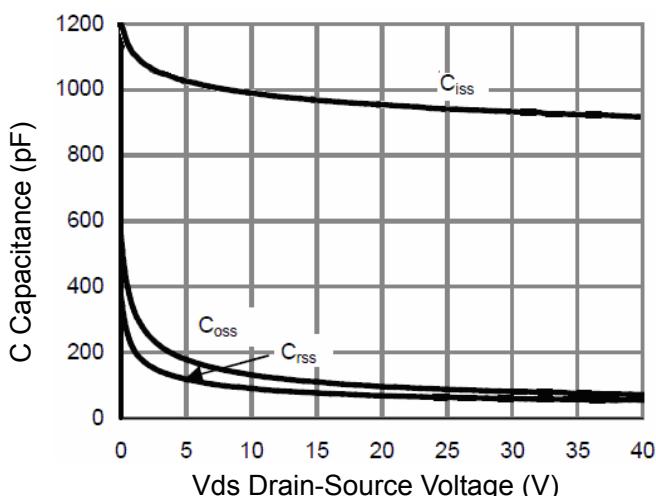


Figure 7 Capacitance vs Vds

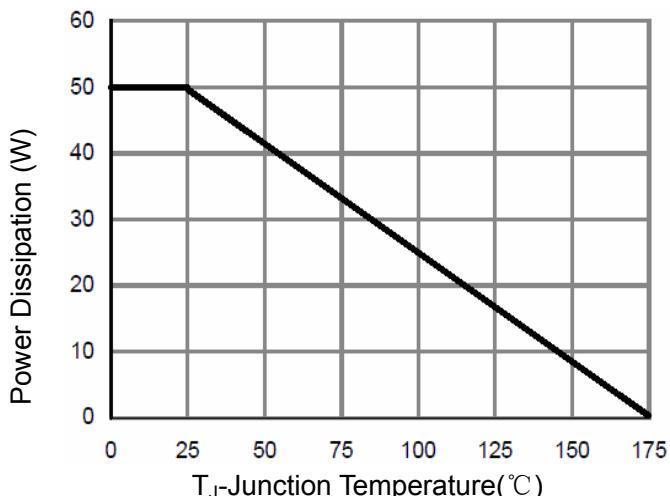


Figure 9 Power De-rating

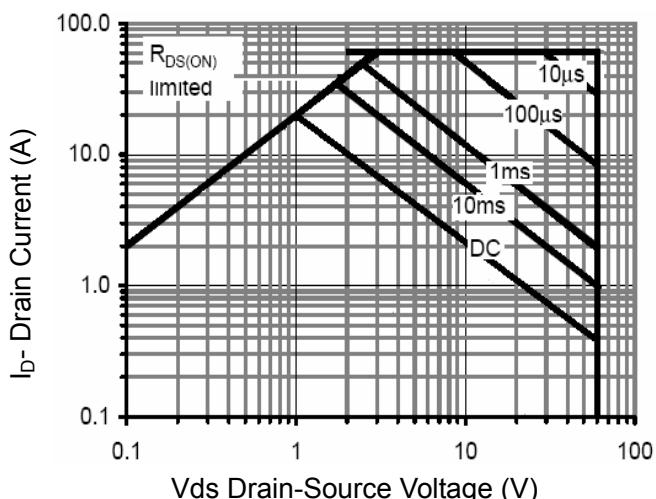


Figure 8 Safe Operation Area

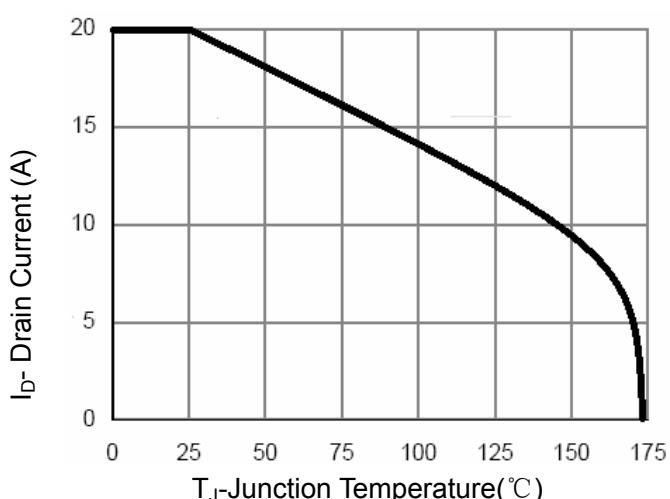


Figure 10 ID Current De-rating

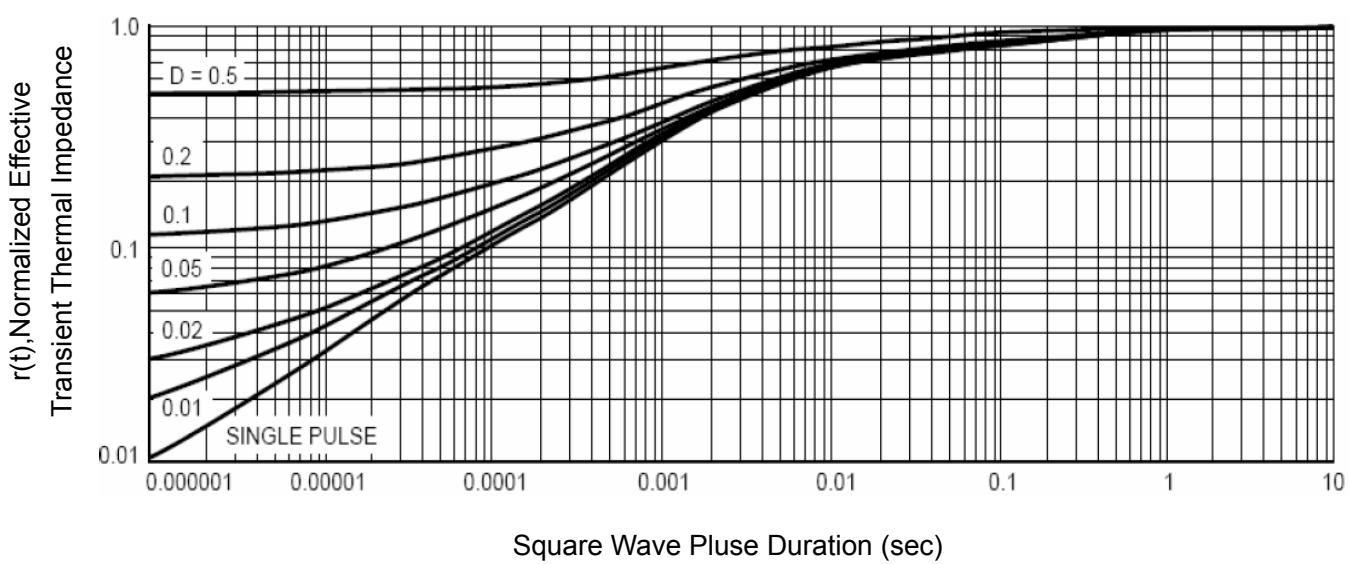


Figure 11 Normalized Maximum Transient Thermal Impedance

**P-Channel Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-60	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=-60\text{V}, V_{\text{GS}}=0\text{V}$	-	-	-1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1	-	-3	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-15\text{A}$	-	-	85	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-8\text{A}$	-	-	135	$\text{m}\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-15\text{A}$	-	10	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	1630.7	-	PF
Output Capacitance	$C_{\text{oss}}$		-	90.6	-	PF
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	77.3	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=-30\text{V}, R_{\text{L}}=1.5\Omega, V_{\text{GS}}=-10\text{V}, R_{\text{G}}=3\Omega$	-	11	-	nS
Turn-on Rise Time	$t_{\text{r}}$		-	14	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	33	-	nS
Turn-Off Fall Time	$t_{\text{f}}$		-	13	-	nS
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}}=-30, I_{\text{D}}=-15\text{A}, V_{\text{GS}}=-10\text{V}$	-	37.6	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	4.3	-	nC
Gate-Drain Charge	$Q_{\text{gd}}$		-	7.2	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=-15\text{A}$	-		-1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$I_{\text{s}}$		-	-	-15	A
Reverse Recovery Time	$t_{\text{rr}}$	$T_J = 25^\circ\text{C}, IF = -15\text{A}$ $di/dt = -100\text{A}/\mu\text{s}$ <sup>(Note 3)</sup>	-	35	-	nS
Reverse Recovery Charge	$Q_{\text{rr}}$		-	38	-	nC
Forward Turn-On Time	$t_{\text{on}}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

### P-Channel Typical Electrical and Thermal Characteristics (Curves)

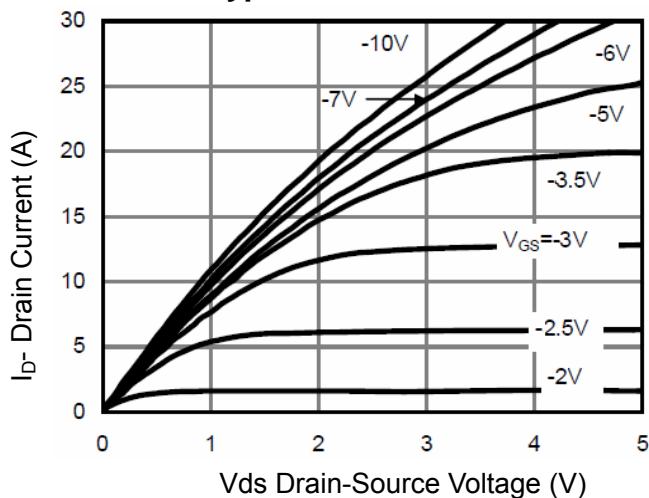


Figure 1 Output Characteristics

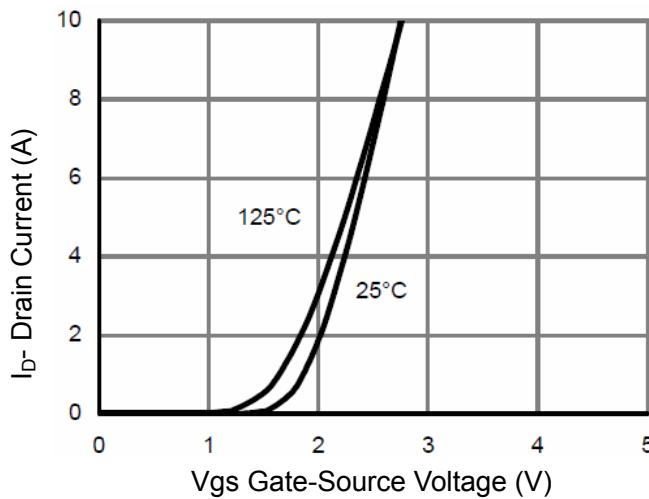


Figure 2 Transfer Characteristics

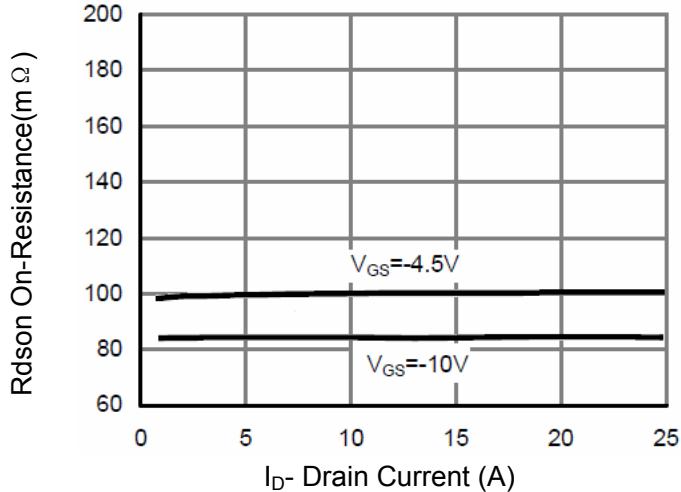


Figure 3 Rdson- Drain Current

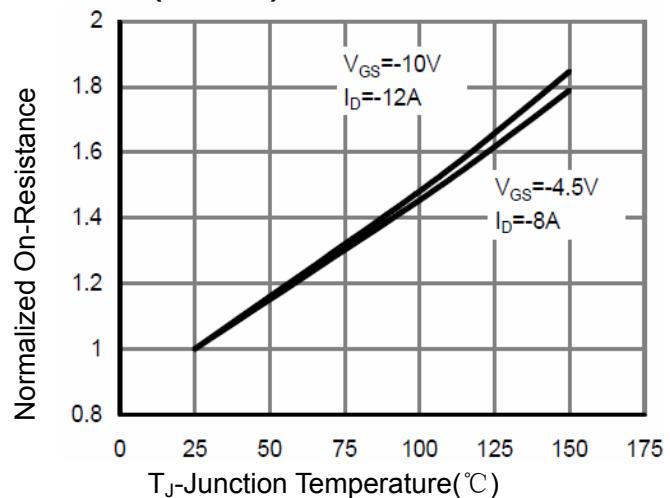


Figure 4 Rdson-Junction Temperature

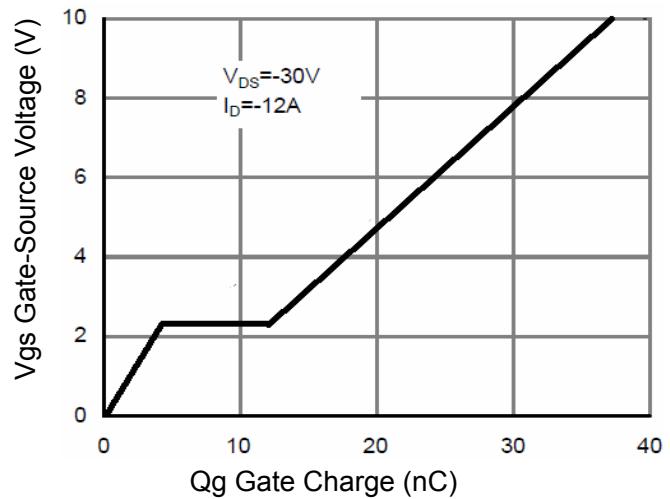


Figure 5 Gate Charge

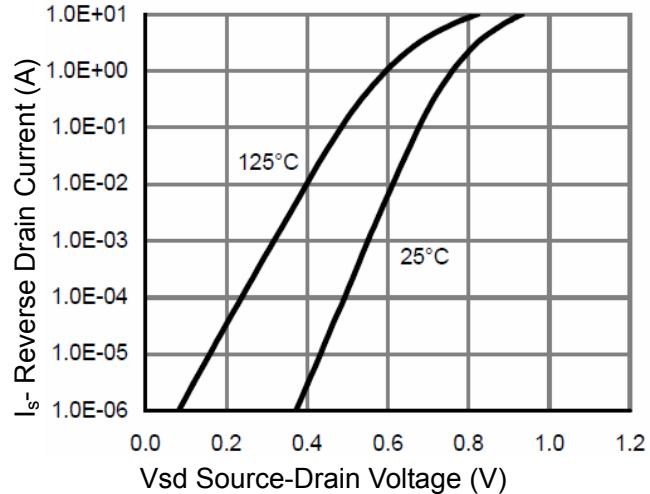
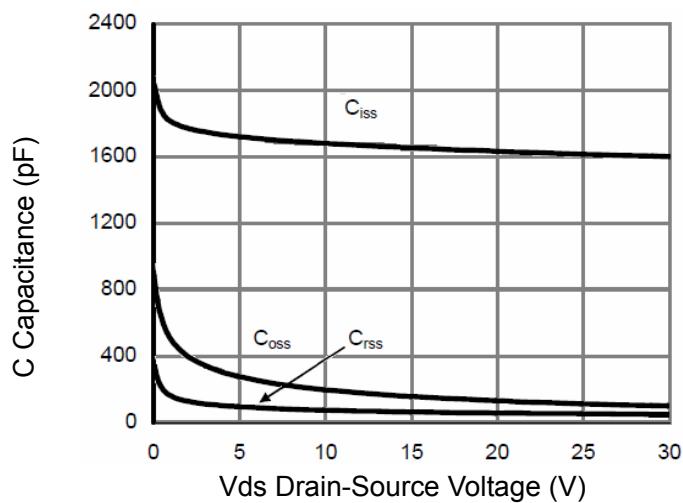
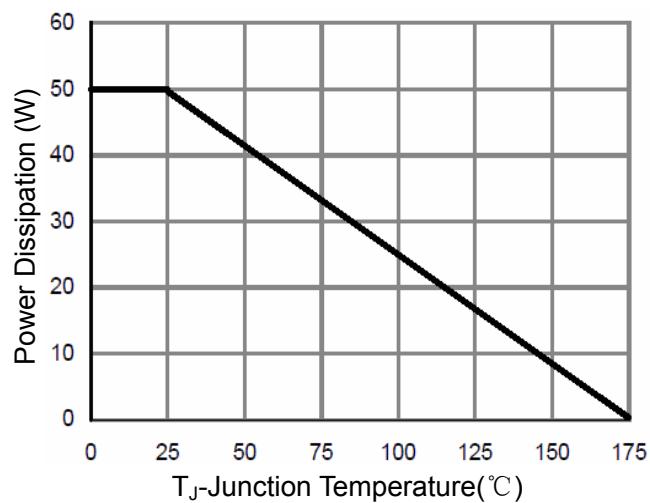


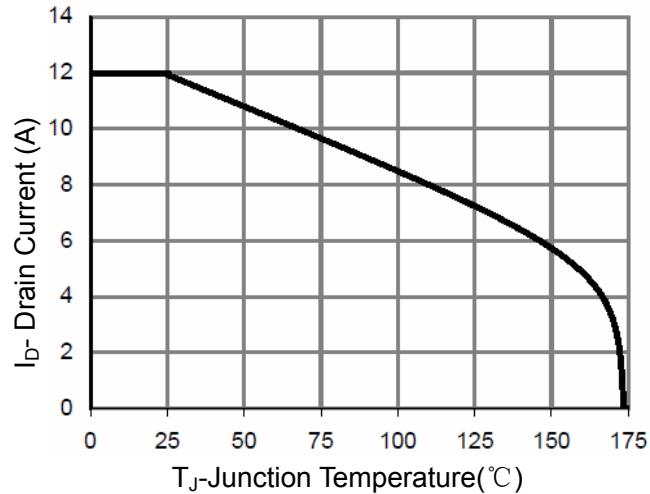
Figure 6 Source- Drain Diode Forward



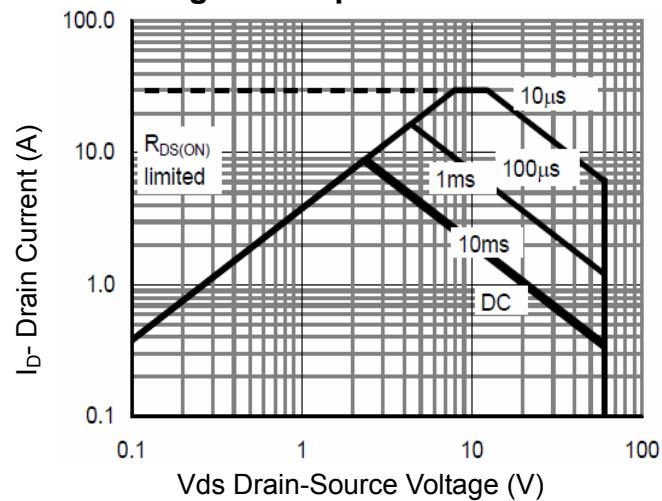
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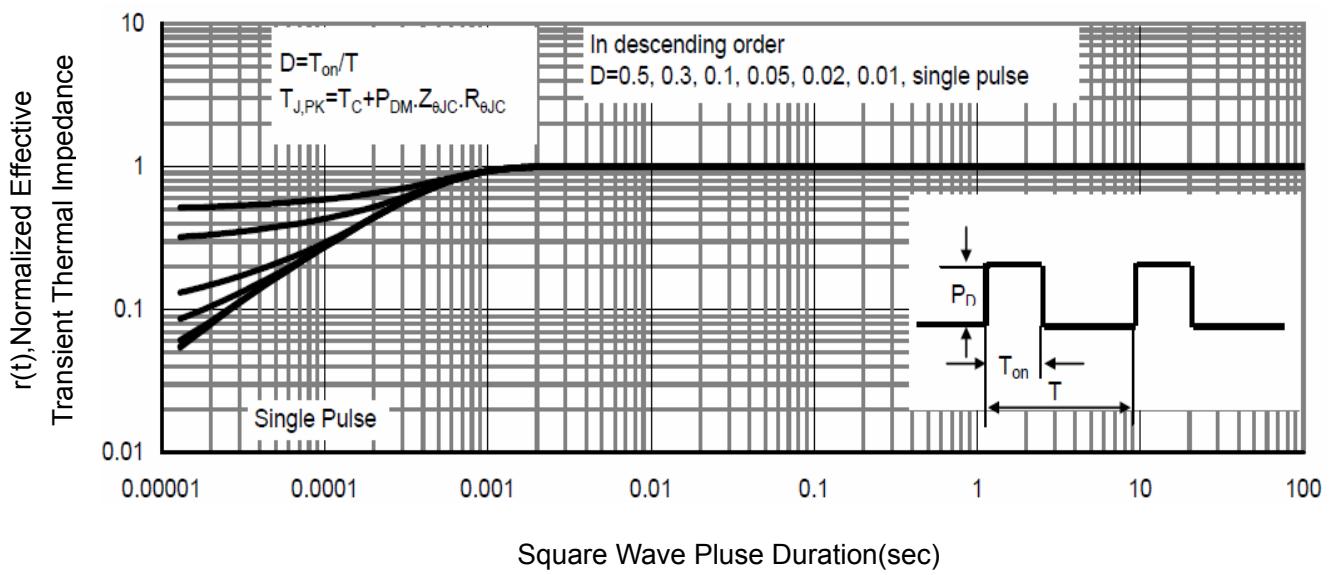
**Figure 9 Power De-rating**



**Figure 10 ID Current De-rating**

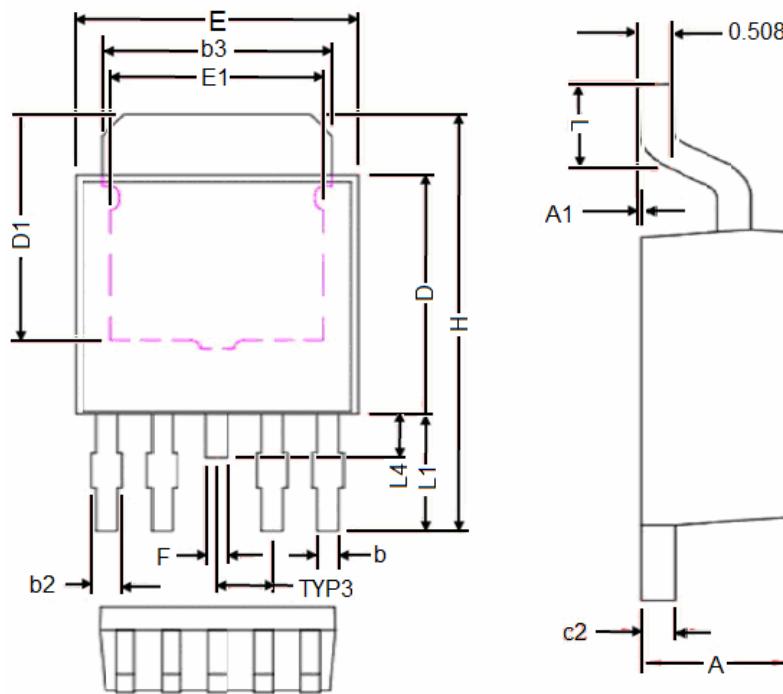


**Figure 8 Safe Operation Area**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

## TO-252-4L Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	2.20	2.30	2.40
A1	0	0.08	0.15
b	0.45	0.53	0.60
b2	0.50	0.65	0.80
b3	5.20	5.35	5.50
c2	0.45	0.50	0.55
D	5.40	5.60	5.80
D1	4.57	-	-
E	6.40	6.60	6.80
E1	3.81	-	-
e	1.27 REF.		
E1	3.81	-	-
F	0.40	0.50	0.60
H	9.40	9.80	10.20
L	1.40	1.59	1.77
L1	2.40	2.70	3.00
L4	0.80	1.00	1.20